David Chen 2015/7/2, Version1

Requirement Description:

The PCB size is limated of some kind of application , so external crystal can't be used . For example , space restricted on magnetic head of smart car reader . The PCB size smaller than 10x10mm . The RTC function is required , but external crystal can't be used . However , Freescale Kinetis RTC not support internal reference clock (IRC) .

Below image copy from K65 datasheet.

The time counter within the RTC is clocked by a 32.768 kHz clock and can supply this clock to other peripherals. The 32.768 kHz clock can only be sourced from an external crystal using the oscillator that is part of the RTC module.

Module	Bus interface clock	Internal clocks	I/O interface clocks	
RNGA	Bus clock	22	02	
	A	nalog		
ADC	Bus clock	OSCERCLK	=	
CMP	Bus clock		-	
VREF	Flash clock	-	-	
	TI	mers		
TPM	Bus clock	TPM clock	TPM_CLKINO, TPM_CLKIN	
PDB	Bus clock	=	_	
FlexTimers	Bus clock	MCGFFCLK	FTM_CLKINx	
PIT	Bus clock	=	-	
LPTMR	Flash clock	LPO,OSCERCLK_UNDIV, MCGIRCLK, ERCLK32K	~	
CMT	Bus clock	=	-	
RTC	Flash clock	EXTAL32	-	

Table 6-2. Module clocks (continued)

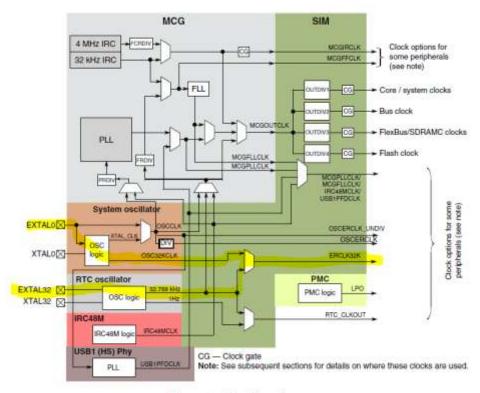
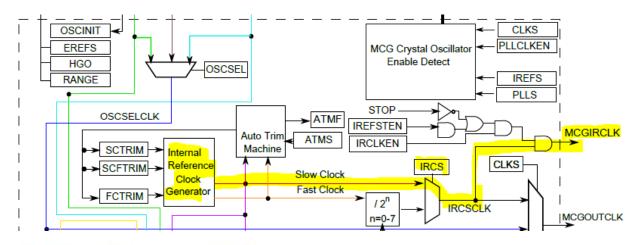


Figure 6-1. Clocking diagram

Solution description:

1. Internal Clock Source:

- a. There is a MCG output clock MCGIRCLK can be configured as slow speed internal reference clock (32.768KHz). Another word, internal reference clock 32.768KHz can be selected as MCGIRCLK clock source.
 - i. MCG C2[IRCS] = 0 //slow internal reference clock selected
 - ii. MCG C1[IRCLKEN] = 1 // MCGIRCLK active
 - iii. MCG C1[IREFSTEN] = 1 //IRC enabled in STOP mode
- MCG Internal Reference Clock (MCGIRCLK) is provided as a clock source for other on-chip peripherals



27.5.3.1 MCG Internal Reference Clock

The MCG Internal Reference Clock (MCGIRCLK) provides a clock source for other onchip peripherals and is enabled when C1[IRCLKEN]=1. When enabled, MCGIRCLK is driven by either the fast internal reference clock (4 MHz IRC which can be divided down by the FRDIV factors) or the slow internal reference clock (32 kHz IRC). The IRCS

Clock name	High Speed Run mode clock frequency	Run mode clock frequency	VLPR mode clock frequency	Clock source	Clock is disabled when	
Internal reference (MCGIRCLK)	30-40 kHz or 4 MHz	30-40 kHz or 4 MHz	4 MHz only	MCG	MCG_C1[IRCLKEN] cleared, Stop or VLPS mode and MCG_C1[IREFSTE N] cleared, or LLS/VLLS mode	

MCG_C2 field descriptions (continued)

Field	Description					
1 LP	Low Power Select					
	Controls whether the FLL or PLL is disabled in BLPI and BLPE modes. In FBE or PBE modes, setting this bit to 1 will transition the MCG into BLPE mode; in FBI mode, setting this bit to 1 will transition the MCG into BLPI mode. In any other MCG mode, LP bit has no affect.					
	O FLL or PLL is not disabled in bypass modes. 1 FLL or PLL is disabled in bypass modes (lower power)					
0 IRCS	Internal Reference Clock Select					
	Selects between the fast or slow internal reference clock source.					
	0 Slow internal reference clock selected.					
	1 Fast internal reference clock selected.					

MCG_C1 field descriptions

Fleid	Description				
1 IRCLKEN	Internal Reference Clock Enable				
MOEREN	Enables the internal reference clock for use as MCGIRCLK.				
	0 MCGIRCLK inactive.				
	MCGIRCLK active.				

MCG_C1 field descriptions (continued)

Field	Description						
0 IREFSTEN	Internal Reference Stop Enable						
microren,	Controls whether or not the internal reference clock remains enabled when the MCG enters Stop mode.						
	Internal reference clock is disabled in Stop mode.						
	1 Internal reference clock is enabled in Stop mode if IRCLKEN is set or if MCG is in FEI, FBI, or BLPI modes before entering Stop mode.						

2. Clock output pin:

a. There is a CLKOUT pin on Kinetis and its clock source can be configured from MCGIRCLK.

```
    i. SIM_SCGC5[PORTx] = 1 // enable PORTx clock gate
    ii. PORTx_PCRn[MUX] = b101 // configure pin muxing slot as alternative 5 as CKLOUT
    iii. SIM_SOPT2[CLKOUTSEL] = b100 // MCGIRCLK output on CLKOUT pin
```

SIM_SOPT2 field descriptions (continued)

Field	Description
	MCGOUTCLK, divided by the TRACECLK fractional divider as configured by SIM_CLKDIV4[TRACEFRAC, TRACEDIV] Core/system clock
11 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
10 Reserved	This field is reserved. This read-only field is reserved and always has the value 0.
9–8 FBSL	FlexBus security level If flash security is enabled, then this field affects what CPU operations can access off-chip via the FlexBus or SDRAMinterface. This field has no effect if flash security is not enabled. On All off-chip accesses (instruction and data) via the FlexBus or SDRAM are disallowed. All off-chip accesses (instruction and data) via the FlexBus or SDRAM are disallowed. Off-chip instruction accesses are disallowed. Data accesses are allowed. Off-chip instruction accesses and data accesses are allowed.
7–5 CLKOUTSEL	Selects the clock to output on the CLKOUT pin. OOO FlexBus CLKOUT OO1 Reserved O10 Flash clock O11 LPO clock (1 kHz) 100 MCGIRCLK 101 RTC 32.768kHz clock 111 IRC 48 MHz clock

SIM_SCGC5 field descriptions

Field	Description					
13 PORTE	Port E Clock Gate Control This bit controls the clock gate to the Port E module. Clock disabled Clock enabled					
12 PORTD	Port D Clock Gate Control This bit controls the clock gate to the Port D module. 0 Clock disabled 1 Clock enabled					
11 PORTC	Port C Clock Gate Control This bit controls the clock gate to the Port C module.					

Pinout

169 WLC SP	169 MAP BGA	Pin Name	Default	ALT0	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7	EzPort
N5	M10	PTA6	DISABLED		PTA6		FTM0_CH3		CLKOUT		TRACE_ CLKOUT	
B1	A12	PTC3/ LLWU_P7	CMP1_IN1	CMP1_IN1	PTC3/ LLWU_P7	SPI0_PCS1	UART1_RX	FTM0_CH2	CLKOUT	I2SO_TX_ BCLK		

3. Reference Source code:

```
/*Enable I/O port clock gate */
SIM_HAL_EnableClock(SIM, kSimClockGatePortC);
   /*Configure I/O as clock output pin */
PORT_HAL_SetMuxMode(PORTC, 3UL, kPortMuxAlt5);
   /*Select MCGIRCLK as CLKOUT pin output source */
CLOCK_HAL_SetClkOutSel(SIM , kClockClkoutSelMcgIrClk);
```

4. Hardware:

Connect CLKOUT pin to EXTAL32 for RTC clock source.

Note:

1. The internal 32kHz OSC deviation is around ±2%.

3.3.1 MCG specifications

Table 16. MCG specifications

Symbol	Description	Min.	Тур.	Max.	Unit	Notes
f _{ints_ft}	Internal reference frequency (slow clock) — factory trimmed at nominal VDD and 25 °C	31 <u>—25</u>	32.768	_	kHz	
f _{ints_t}	Internal reference frequency (slow clock) — user trimmed	31.25	=	39.0625	kHz	
lints	Internal reference (slow clock) current	in the	20	-	μА	
Δf _{dco_res_t}	Resolution of trimmed average DCO output frequency at fixed voltage and temperature — using SCTRIM and SCFTRIM	7 <u></u>	± 0.3	± 0.6	%f _{dco}	1
∆f _{dco_res_t}	Resolution of trimmed average DCO output frequency at fixed voltage and temperature — using SCTRIM only	3 <u>1 - 1 - 1</u>	± 0.2	± 0.5	%f _{dco}	1
Δf_{dco_t}	Total deviation of trimmed average DCO output frequency over voltage and temperature	<u> </u>	± 0.5	± 2	%f _{dco}	1
∆f _{dco_t}	Total deviation of trimmed average DCO output frequency over fixed voltage and temperature range of 0-70°C	7 <u></u>	± 0.3	1.5	%f _{dco}	1